EUV High-NA Wavefront Sensing

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ISt GEN EUV

NA: 0.33 (ISOMORPHIC)



Sascha Migura et al., Proc. SPIE 9661, 31st European Mask and Lithography Conference, 96610T (4 September 2015);

ISE GENEUV

NA: 0.33 (ISOMORPHIC)



Sascha Migura et al., Proc. SPIE 9661, 31st European Mask and Lithography Conference, 96610T (4 September 2015);

2nd GEN EUV

NA: 0.55 (ANAMORPHIC)







CXRO EUV Program Overview

EUV Lithography tools





Demonstration of 15-nm half-pitch Naulleau, et. al. EUVLS 2010





Engineered coherence



11,400 resist + UL + dev combinations tested to date.





Scatterometry and coating characterization



- Spectral purity: 99.98%
- Dynamic range: 10¹⁰

EUV Mask Inspection

 $\lambda = 13.5 \text{ nm}$

4×NA: 0.25–0.625

Programmable σ

Full-mask Nav

5–10 sec/image

sharp.lbl.gov



Resist characterization

Sensitivity & contrast of EUV resists Dose Calibration Tool (DCT)





- High-NA Lateral shearing interferometry
- Laplacian wavefront sensor
- Zone plate test station



WHY DO WE NEED WAVEFRONT SENSING?

$d_{\min} \ge k$



WHY DO WE NEED WAVEFRONT SENSING?

ANSWER: TO CHARACTERIZE AND MINIMIZE ABERRATIONS FOR OPTIMAL IMAGING







Object

Image

Object



Image

Object



Image

Object



Image

ABERRATED OPTICAL SYSTEM

Imaging optic

Object

Image

POINT SPREAD FUNCTION (BLUR)



POINT SPREAD FUNCTION (BLUR)



MASK TRANSMISSION







POINT SPREAD FUNCTION (BLUR)



MASK TRANSMISSION



AERIAL IMAGE





DIFFRACTION LIMITED





DIFFRACTION LIMITED





ABERRATION LIMITED



 $d_{\min} \ge k_1 \frac{\lambda}{\lambda}$

High-NA EUV wavefront sensos







LAPLACIAN WAVEFRONT SENSOR (LWS)



LATERAL SHEARING INTERFEROMETRY

LSI working principle RETICLE (LSI SOURCE)

FROM ALS

OPTIC

GRATING

CCD

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"INTERFEROMETRY MODE"

SHEARING INTERFEROMETER



LSI working principle

GRATING CCD

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 $\phi_{x} = w(x + s, y) - w(x, y)$ $\phi_{y} = w(x, y + s) - w(x, y)$ +1 U

LSI working principle

 $\phi_{x} = w(x + s, y) - w(x, y)$

LEAST SQUARES ALGORITHM

(High-NA or low-NA)

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$\phi_{Y} = w(x, y + s) - w(x, y)$

RECONSTRUCTED WAVEFRONT

Adapting LSI to high NA





$w(x + s, y) - w(x, y) \approx S \cdot dw/dx$



Adapting LSI to high NA





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$w(x + s, y) - w(x, y) \approx S \cdot dw/dx$

$w(x + s, y) - w(x, y) \neq S \cdot dw/dx$

Multiplexed source requirements

Reticle multiplexed point source field

d **Source** <u>constraints</u>: \cdot Reticle and wafer grating periods obey: $T = mT_w$

- Coherence function of illumination: w_c < T
- Point source diffraction + illumination NA fill pupil NA



Disk illumination (0.3 σ)





GRATING ON HEXAPOD

WAFER PRINT MODULE

INTERFEROMETRY MODULE

IN-VACUUM CCD



Optical alignment 10/31/18 Pre-alignment Post



RMS WFE: 0.69 nm

Measurements taken at field center. Specification is 0.50 nm

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Post-alignment



RMS WFE: 0.31 nm



Zernike decomposition of optical aberrations

Pre-alignment









Printing improvement

Before alignment



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After alignment



LAPACIAN WAVEFRONT SENSOR

IDEAL OPTICAL SYSTEM

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ABERRATED OPTICAL SYSTEM

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EXAMPLE: X-COMA







EXAMPLE: X-COMA







Curvature library

BUILD A CURVATURE LIBRARY FOR SET OF ZERNIKE TERMS

Ν	Aberration	
3	Focus	
4	Stig 🚺	
5	Stig 🌔	
6	Coma 🥃	
7	Coma 🌔	
8	Spherical 🧿	
9	Trifoil	
10	Trifoil	







LWS reconstruction

Curvature library

Ν	Aberrati	ion	Probe	Δf
3	Focus 🤇		•	[+,-,+,-,-,+]
4	Stig 🜔)	•	[-,-,+, -, -, +]
5	Stig 🧲			[-,-,+, +, -, +]
6	Coma		•	[+,-,+, -, +, +
7	Coma 🬔		•	[+,+,+, -, -, +
8	Spherical 🤇	•		[-,+,+,+,-,+
9	Trifoil 🧯		•	[+,-,-, -, -, +]
10	Trifoil 🌔		•	[+,-,-,+,+,+

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LWS reconstruction

Curvature library





Curvature library

Ν	Aberration	Probe	Δf
3	Focus 🔘		[+,-,+,-,-,+]
4	Stig 🚺		[-,-,+, -, -, +]
5	Stig 🛟		[-,-,+, +, -, +]
6	Coma 🤤		[+,-,+,-,+,+]
7	Coma 🚺		[+,+,+,-,-,+]
8	Spherical 🧿		[-,+,+,+,-,+]
9	Trifoil 🚺		[+,-,-,-,+]
10	Trifoil		[+,-,-,+,+,+]







LWS experiment on SHARP



NA: 0.33 / 4lambda: 13.5 nmData sets: 13 (4 gratings)Focus steps: $17 @ \Delta z = 300 \text{ nm}$ Field locations: 25





LWS experiment on SHARP



Zernike	Average peak-to-valley error mλ (pm)	Average peak-to-valley er λ/x
Focus (Z ₃)	3.01 (40.6)	λ/331
Astigmatism XY (Z ₄)	1.82 (24.6)	λ/549
Astigmatism 45° (Z ₅)	4.18 (56.4)	λ/238
Coma X (Z ₆)	1.75 (23.7)	λ/571
Coma Y (Z ₇)	1.94 (26.2)	λ/514
Spherical (Z ₈)	1.37 (18.5)	λ/726
Total RMS error	2.78 (37.5)	λ/359





3 4 5

4 5

2

2 3

1.75 mλ

(23.7 pm)

1

5

4

3

2

4

3

2

1

0.015

0.005

-0.005

-0.01

0.015

0.01

0.005

-0.005

-0.01

-0.015

-0.015

3

1

2

1

3

1.94 mλ

(26.2 pm)

0.01



2 3 4 5

4 5



2 3 4 5 1 1.37 mλ (18.5 pm)

Single aberration peak-to-valley error better than $\lambda/238$ Total RMS aberration $\lambda/359$

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Summary of high-NA wavefront sensors

Lateral Shearing Interferometry (LSI)

- Works by measuring wavefront derivative
- Interferometric method (requires integration) of diffraction grating and CCD)
- Good sensitivity to all figure Zernike terms
- Fast measurement (between 1 and 36 data points) Lots of data required (> 100 images)
- High accuracy demonstrated (λ /100)



Laplacian Wavefront Sensor (LWS)

- Works by measuring wavefront curvature (focus shifts)
- Image-based method
- Ideal for measuring primary Zernikes terms (Z₄ - Z₉)

• Extremely high accuracy demonstrated ($\lambda/230$)





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